

## TRADEMARK ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	SECURITY AGREEMENT SUPPLEMENT		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
FIBER MATERIALS INC.		01/20/2012	CORPORATION: DELAWARE
RECEIVING PARTY DATA			
Name:	JPMORGAN CHASE BANK, N.A., as Collateral Agent		
Street Address:	PO BOX 2558		
City:	HOUSTON		
State/Country:	TEXAS		
Postal Code:	77252-2558		
Entity Type:	Association: UNITED STATES		
PROPERTY NUMBERS Total: 4			
Property Type	Number	Word Mark	
Registration Number:	1219966	FMI	
Registration Number:	1219967	"FMI....FOR MATERIALS INGENUITY"	
Registration Number:	1063329	FIBERFORM	
Registration Number:	1696944	C3	
CORRESPONDENCE DATA			
Fax Number:	(866)826-5420		
Phone:	301-638-0511		
Email:	ipresearchplus@comcast.net		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>			
Correspondent Name:	IP Research Plus, Inc.		
Address Line 1:	21 Tadcaster Circle		
Address Line 2:	attn: Penelope J.A. Agodoa		
Address Line 4:	Waldorf, MARYLAND 20602		
ATTORNEY DOCKET NUMBER:	37687		

OP \$115.00 1219966

NAME OF SUBMITTER:	Penelope J.A. Agodoa
Signature:	/pja/
Date:	01/25/2012
<p>Total Attachments: 20 source=37687#page1.tif source=37687#page2.tif source=37687#page3.tif source=37687#page4.tif source=37687#page5.tif source=37687#page6.tif source=37687#page7.tif source=37687#page8.tif source=37687#page9.tif source=37687#page10.tif source=37687#page11.tif source=37687#page12.tif source=37687#page13.tif source=37687#page14.tif source=37687#page15.tif source=37687#page16.tif source=37687#page17.tif source=37687#page18.tif source=37687#page19.tif source=37687#page20.tif</p>	

### RECORDATION FORM COVER SHEET TRADEMARKS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies):**

FIBER MATERIALS INC.

- Individual(s)                       Association  
 General Partnership               Limited Partnership  
 Corporation- State: DELAWARE  
 Other \_\_\_\_\_

Citizenship (see guidelines) UNITED STATES

Additional names of conveying parties attached?  Yes  No

**3. Nature of conveyance )/Execution Date(s) :**

Execution Date(s) JANUARY 20, 2012

- Assignment                               Merger  
 Security Agreement                       Change of Name  
 Other SECURITY AGREEMENT SUPPLEMENT

**2. Name and address of receiving party(ies)**

Additional names, addresses, or citizenship attached?  Yes  
 No

Name: JPMORGAN CHASE BANK, N.A., as Collateral Agent

Internal

Address: \_\_\_\_\_

Street Address: PO BOX 2558

City: HOUSTON

State: TEXAS

Country: UNITED STATES                      Zip: 77252-2558

- Association                      Citizenship UNITED STATES  
 General Partnership                      Citizenship \_\_\_\_\_  
 Limited Partnership                      Citizenship \_\_\_\_\_  
 Corporation                      Citizenship \_\_\_\_\_  
 Other \_\_\_\_\_                      Citizenship \_\_\_\_\_

If assignee is not domiciled in the United States, a domestic representative designation is attached:  Yes  No  
(Designations must be a separate document from assignment)

**4. Application number(s) or registration number(s) and identification or description of the Trademark.**

A. Trademark Application No.(s)  
PLEASE SEE ATTACHED SCHEDULE

B. Trademark Registration No.(s)  
PLEASE SEE ATTACHED SCHEDULE

Additional sheet(s) attached?  Yes  No

C. Identification or Description of Trademark(s) (and Filing Date if Application or Registration Number is unknown):

**5. Name & address of party to whom correspondence concerning document should be mailed:**

Name: IP Research Plus

Internal Address: \_\_\_\_\_

Attn: Penelope J.A. Agodoa

Street Address: \_\_\_\_\_

21 Tadcaster Circle

City: Waldorf

State: MD                                      Zip: 20602

Phone Number: 301-638-0511

Fax Number: 866-826-5420

Email Address: orders@ipresearchplus.com

**6. Total number of applications and registrations involved:**

4

**7. Total fee (37 CFR 2.6(b)(6) & 3.41) \$** \_\_\_\_\_

- Authorized to be charged by credit card  
 Authorized to be charged to deposit account  
 Enclosed

**8. Payment Information:**

a. Credit Card                      Last 4 Numbers \_\_\_\_\_  
Expiration Date \_\_\_\_\_

b. Deposit Account Number \_\_\_\_\_

Authorized User Name \_\_\_\_\_

**9. Signature:**

  
Signature

January 25, 2012

Date

Jessica Levin

Name of Person Signing

Total number of pages including cover sheet, attachments, and document: 20

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

## **IP SECURITY AGREEMENT SUPPLEMENT**

### FIBER MATERIALS and INTERMAT

SUPPLEMENT NO. 2 dated as of January 20, 2012 (this "Supplement"), to the Amended and Restated Intellectual Property Security Agreement dated as of April 28, 2010, as supplemented by Supplement No. 1 dated as of November 30, 2010 and reaffirmed by the Reaffirmation Agreement dated as of October 7, 2011 (as so supplemented and reaffirmed, the "Intellectual Property Security Agreement"), made by GRAFTECH INTERNATIONAL LTD., a Delaware corporation ("GrafTech"), GRAFTECH FINANCE INC., a Delaware corporation ("Finance" and, together with GrafTech Switzerland S.A., the "Borrowers"), and the other subsidiaries of GrafTech from time to time party thereto (together with GrafTech and Finance, the "Grantors") in favor of JPMORGAN CHASE BANK, N.A. as collateral agent for the Secured Parties (such term and each other capitalized term used but not defined herein having the meaning given it in the Intellectual Property Security Agreement, and if not defined therein, having the meaning given it in the Credit Agreement (as defined below)).

A. Reference is made to the Amended and Restated Credit Agreement dated as of October 7, 2011 (as the same may be amended, supplemented or otherwise modified from time to time, the "Credit Agreement") among GrafTech, the Borrowers, the LC Subsidiaries from time to time party thereto, the Lenders from time to time party thereto and JPMorgan Chase Bank, N.A., as Administrative Agent, Collateral Agent and Issuing Bank.

B. The Grantors have entered into the Intellectual Property Security Agreement in order to induce the Lenders to make Loans and the Issuing Banks to issue Letters of Credit pursuant to, and upon the terms and subject to the conditions specified in, the Credit Agreement. Pursuant to Section 5.11 of the Credit Agreement (and the requirement thereunder that all actions be taken in order to cause the Collateral and Guarantee Requirement to be satisfied at all times), certain Subsidiaries are required to enter into the Intellectual Property Security Agreement as a Grantor upon the occurrence of certain events. Section 6.14 of the Intellectual Property Security Agreement provides that additional Subsidiaries may become Grantors under the Intellectual Property Security Agreement by execution and delivery of an instrument in the form of this Supplement. Each of the undersigned, Fiber Materials Inc. f/k/a GrafTech Delaware IV Inc., a Delaware corporation and 100% owned subsidiary of GrafTech ("Fiber Materials"), and Intermat, a Maine corporation and 100% owned subsidiary of Fiber Materials ("Intermat" and, together with Fiber Materials, the "New Grantors", and each, a "New Grantor"), is a Subsidiary and is executing this Supplement in accordance with the requirements of the Credit Agreement to become a Grantor under the Intellectual Property Security Agreement in order to induce the Lenders to make additional Loans and the Issuing Bank to issue additional Letters of Credit and as consideration for Loans previously made and Letters of Credit previously issued.

Accordingly, the Collateral Agent and the New Grantors agree as follows:

SECTION 1. In accordance with Section 6.14 of the Intellectual Property Security Agreement, each of the New Grantors by its signature below becomes a Grantor under the Intellectual Property Security Agreement with the same force and effect as if originally named therein as a Grantor and hereby grants to the Collateral Agent a security interest in the Collateral named therein (including but not limited to the Collateral set forth on Schedule I attached hereto), and each of the New Grantors hereby agrees to all the terms and provisions of the Intellectual Property Security Agreement applicable to it as a Grantor thereunder. Each reference to a "Grantor" in the Intellectual Property Security Agreement shall be deemed to include the New Grantors. The Intellectual Property Security Agreement is hereby incorporated herein by reference.

SECTION 2. (a) Each of the New Grantors represents and warrants to the Secured Parties that this Supplement has been duly authorized, executed and delivered by it and constitutes its legal, valid and binding obligation, enforceable against it in accordance with its terms, subject to the effects of applicable bankruptcy, insolvency or similar laws effecting creditors' rights generally and equitable principles of general applicability.

(b) Each of the New Grantors hereby represents and warrants that Schedule I attached hereto includes a true and correct listing of all the Collateral owned by it as of the date hereof.

SECTION 3. This Supplement may be executed in two or more counterparts, each of which shall constitute an original, but all of which, when taken together, shall constitute but one instrument. This Supplement shall become effective when the Collateral Agent shall have received counterparts of this Supplement that, when taken together, bear the signatures of the New Grantors and the Collateral Agent.

SECTION 4. Except as expressly supplemented hereby, the Intellectual Property Security Agreement shall remain in full force and effect.

**SECTION 5. THIS SUPPLEMENT SHALL BE GOVERNED BY, AND CONSTRUED IN ACCORDANCE WITH, THE LAWS OF THE STATE OF NEW YORK.**

SECTION 6. In the event any one or more of the provisions contained in this Supplement or in any other Loan Document should be held invalid, illegal or unenforceable in any respect, the validity, legality and enforceability of the remaining provisions contained herein and therein shall not in any way be affected or impaired thereby (it being understood that the invalidity of a particular provision in a particular jurisdiction shall not in and of itself affect the validity of such provision in any other jurisdiction). The parties shall endeavor in good-faith negotiations to replace the invalid, illegal or unenforceable provisions with valid provisions the economic effect of which comes as close as possible to that of the invalid, illegal or unenforceable provisions.

SECTION 7. All communications and notices hereunder shall be in writing and given as provided in the Intellectual Property Security Agreement. All communications and notices hereunder to a New Grantor shall be given to it at the address set forth under its

signature, with a copy to GrafTech, as such address may be changed in accordance with the Intellectual Property Security Agreement.

[Remainder of Page Intentionally Left Blank]

IN WITNESS WHEREOF, the New Grantors and the Collateral Agent have duly executed this Supplement to the Intellectual Property Security Agreement as of the day and year first above written.

FIBER MATERIALS INC.,

By



\_\_\_\_\_  
Name: Quinn J. Coburn  
Title: Vice President and Treasurer  
Address:  
5 Morin Street  
Biddeford, ME 04005

INTERMAT,

By



\_\_\_\_\_  
Name: Quinn J. Coburn  
Title: Attorney-in-Fact  
Address:  
389 Hill Street  
Biddeford, ME 04005

JPMORGAN CHASE BANK, N.A., as  
Collateral Agent,

By

\_\_\_\_\_  
Name:  
Title:

IN WITNESS WHEREOF, the New Grantors and the Collateral Agent have duly executed this Supplement to the Intellectual Property Security Agreement as of the day and year first above written.

FIBER MATERIALS INC.,

By

\_\_\_\_\_  
Name: Quinn J. Coburn  
Title: Vice President and Treasurer  
Address:  
5 Morin Street  
Biddeford, ME 04005

INTERMAT,

By

\_\_\_\_\_  
Name: Quinn J. Coburn  
Title: Attorney-in-Fact  
Address:  
389 Hill Street  
Biddeford, ME 04005

JPMORGAN CHASE BANK, N.A., as  
Collateral Agent,

By

\_\_\_\_\_  
Name:   
Title: Brian Knapp  
Vice President



SCHEDULE I TO SUPPLEMENT NO. 2  
TO INTELLECTUAL PROPERTY SECURITY AGREEMENT

I. PATENTS OWNED BY FIBER MATERIALS INC.

U.S. Patent Grants

<u>Issue Date</u>	<u>Patent Numbers</u>
NONE	

U.S. Patent Applications

<u>Filing Date</u>	<u>Patent Application No.</u>
NONE	

Non-U.S. Patent Grants

<u>Country</u>	<u>Issue Date</u>	<u>Patent No.</u>
NONE		

Non-U.S. Patent Applications

<u>Country</u>	<u>Filing Date</u>	<u>Patent Application No.</u>
NONE		

II. TRADEMARK/TRADE NAMES OWNED BY FIBER MATERIALS INC.

U.S. Trademark Registrations

<u>Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
FMI	December 14, 1982	1,219,966
FMI...FOR MATERIALS INGENUITY	December 14, 1982	1,219,967
FIBERFORM C3	April 12, 1977 June 23, 1992	1,063,329 1,696,944

U.S. Trademark Applications

<u>Mark</u>	<u>Filing Date</u>	<u>Application No.</u>
NONE		

State Trademark Registrations

<u>State</u>	<u>Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
NONE			

State Trademark Applications

<u>State</u>	<u>Mark</u>	<u>Filing Date</u>	<u>Application No.</u>
NONE			

Non-U.S. Trademark Registrations

<u>Country</u>	<u>Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
NONE			

Non-U.S. Trademark Applications

<u>Country</u>	<u>Mark</u>	<u>Application Date</u>	<u>Application No.</u>
NONE			

Trade Names

<u>Country(s) Where Used</u>	<u>Trade Names</u>
NONE	

Common Law (Unregistered) Trademarks

<u>Country(s)/Location(s) Where Used</u>	<u>Trademark</u>
United States	TC -2
United States and Japan	FlexFram
United States	HHN
United States	Ultraloom
United States	Shape Stable Nosetip
United States	FILCARB
United States	SSNT
United States	UltraQuartz

III. COPYRIGHTS OWNED BY FIBER MATERIALS INC.U.S. Copyright Registrations

<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE			

Pending U.S. Copyright Applications for Registration

<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE				

Non-U.S. Copyright Registrations

[[NYCORP:3255297]]  
NY01/SOLOJS/1516621.4

<u>Country</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE				

Non-U.S. Pending Copyright Applications for Registration

<u>Country</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE					

**IV. LICENSES OWNED BY FIBER MATERIALS INC.**

**PART I—LICENSES/SUBLICENSES OF FIBER MATERIALS INC. AS LICENSOR  
ON DATE HEREOF**

**A. COPYRIGHTS**

U.S. Copyright Registrations

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE					

Pending U.S. Copyright Applications for Registration

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Date Filed</u>
NONE					

Non-U.S. Copyright Registrations

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE						

Non-U.S. Pending Copyright Applications for Registration

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicen se</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE							

**B. PATENTS**

U.S. Patents

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Patent Issue Date</u>	<u>Patent No.</u>
NONE			

U.S. Patent Applications

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE			

Non-U.S. Patents

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Patent Issue Date</u>	<u>Non-U.S. Patent No.</u>
NONE				

Non-U.S. Patent Applications

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

## C. TRADEMARKS

U.S. Trademarks

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

U.S. Trademark Applications

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

Non-U.S. Trademarks

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

Non-U.S. Trademark Applications

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

## D. OTHERS

<u>Licensee Name and Address</u>	<u>Date of License/Sublicense</u>	<u>Subject Matter</u>
NONE		

PART 2—LICENSES/SUBLICENSES OF **FIBER MATERIALS INC.** AS LICENSEE  
ON DATE HEREOF

## A. COPYRIGHTS

U.S. Copyright Registrations

<u>Licensor Name and Address</u>	<u>Date of License/Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE					

Pending U.S. Copyright Applications for Registration

<u>Licensor Name and Address</u>	<u>Date of License/Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE						

Non-U.S. Copyright Registrations

<u>Licensor Name and Address</u>	<u>Date of License/Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE					

Non-U.S. Pending Copyright Applications for Registration

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE							

## B. PATENTS

U.S. Patents

<u>Licensor Name and Address</u>	<u>Date of License/Sublicense</u>	<u>Patent Issue Date</u>	<u>Patent No.</u>
NONE			

U.S. Patent Applications

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE			

Non-U.S. Patents

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Patent Issue Date</u>	<u>Non-U.S. Patent No.</u>
NONE				

Non-U.S. Patent Applications

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

## C. TRADEMARKS

U.S. Trademarks

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>U.S. Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
NONE				

U.S. Trademark Applications

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>U.S. Mark</u>	<u>Date Filed</u>	<u>Application No.</u>
NONE				

Non-U.S. Trademarks

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Non-U.S. Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
NONE					

Non-U.S. Trademark Applications

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Non-U.S. Mark</u>	<u>Date Filed</u>	<u>Application No.</u>
NONE					

## D. OTHERS

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Subject Matter</u>
NONE		

## I. PATENTS OWNED BY INTERMAT

U.S. Patent Grants

<u>Issue Date</u>	<u>Patent Numbers</u>
NONE	

U.S. Patent Applications

<u>Filing Date</u>	<u>Patent Application No.</u>
NONE	

Non-U.S. Patent Grants

<u>Country</u>	<u>Issue Date</u>	<u>Patent No.</u>
NONE		

Non-U.S. Patent Applications

<u>Country</u>	<u>Filing Date</u>	<u>Patent Application No.</u>
NONE		

II. TRADEMARK/TRADE NAMES OWNED BY INTERMATU.S. Trademark Registrations

<u>Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
NONE		



U.S. Trademark Applications

<u>Mark</u>	<u>Filing Date</u>	<u>Application No.</u>
NONE		

State Trademark Registrations

<u>State</u>	<u>Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
NONE			

State Trademark Applications

<u>State</u>	<u>Mark</u>	<u>Filing Date</u>	<u>Application No.</u>
NONE			

Non-U.S. Trademark Registrations

<u>Country</u>	<u>Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
NONE			

Non-U.S. Trademark Applications

<u>Country</u>	<u>Mark</u>	<u>Application Date</u>	<u>Application No.</u>
NONE			

Trade Names

<u>Country(s) Where Used</u>	<u>Trade Names</u>
NONE	

III. COPYRIGHTS OWNED BY INTERMATU.S. Copyright Registrations

<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE			

Pending U.S. Copyright Applications for Registration

<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE				

Non-U.S. Copyright Registrations

<u>Country</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE				

Non-U.S. Pending Copyright Applications for Registration

<u>Country</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE					

IV. LICENSES OWNED BY INTERMATPART I—LICENSES/SUBLICENSES OF INTERMAT AS LICENSOR ON  
DATE HEREOF

## A. COPYRIGHTS

U.S. Copyright Registrations

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE					

Pending U.S. Copyright Applications for Registration

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Date Filed</u>
NONE					

Non-U.S. Copyright Registrations

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE						

Non-U.S. Pending Copyright Applications for Registration

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicen se</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE							

## B. PATENTS

U.S. Patents

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Patent Issue Date</u>	<u>Patent No.</u>
NONE			

U.S. Patent Applications

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE			

Non-U.S. Patents

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Patent Issue Date</u>	<u>Non-U.S. Patent No.</u>
NONE				

Non-U.S. Patent Applications

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

## C. TRADEMARKS

U.S. Trademarks

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

U.S. Trademark Applications

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

Non-U.S. Trademarks

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

Non-U.S. Trademark Applications

<u>Country</u>	<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

## D. OTHERS

<u>Licensee Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Subject Matter</u>
NONE		

PART 2—LICENSES/SUBLICENSES OF INTERMAT AS LICENSEE ON DATE HEREOF

## A. COPYRIGHTS

U.S. Copyright Registrations

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE					

Pending U.S. Copyright Applications for Registration

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE						

Non-U.S. Copyright Registrations

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Reg. No.</u>
NONE					

Non-U.S. Pending Copyright Applications for Registration

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Title</u>	<u>Date Pub.</u>	<u>Author</u>	<u>Class</u>	<u>Date Filed</u>
NONE							

## B. PATENTS

U.S. Patents

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Patent Issue Date</u>	<u>Patent No.</u>
NONE			

U.S. Patent Applications

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE			

Non-U.S. Patents

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Patent Issue Date</u>	<u>Non-U.S. Patent No.</u>
NONE				

Non-U.S. Patent Applications

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Date Appl. Filed</u>	<u>Application No.</u>
NONE				

## C. TRADEMARKS

U.S. Trademarks

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>U.S. Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
NONE				

U.S. Trademark Applications

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>U.S. Mark</u>	<u>Date Filed</u>	<u>Application No.</u>
NONE				

Non-U.S. Trademarks

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Non-U.S. Mark</u>	<u>Reg. Date</u>	<u>Reg. No.</u>
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Non-U.S. Trademark Applications

<u>Country</u>	<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Non-U.S. Mark</u>	<u>Date Filed</u>	<u>Application No.</u>
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## D. OTHERS

<u>Licensor Name and Address</u>	<u>Date of License/ Sublicense</u>	<u>Subject Matter</u>
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